# FAIRCHILD

SEMICONDUCTOR

-250 V, -0.55 A, 4.0 Ω

efficiency switching DC/DC converters.

SOT-223

**FQT2P25** 

Description

### November 2013

#### I<sub>D</sub> = -0.275 A • Low Gate Charge (Typ. 6.5 nC)

• Low Crss (Typ. 6.5 pF)

Features

• 100% Avalanche Tested



**P-Channel QFET® MOSFET** 

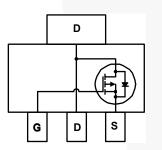
These P-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary,

planar stripe, DMOS technology. This advanced

technology has been especially tailored to minimize on-

state resistance, provide superior switching performance,

and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high



• -0.55 A, -250 V,  $R_{DS(on)}$  = 4.0  $\Omega$  (Max.) @  $V_{GS}$  = -10 V,

### Absolute Maximum Ratings T<sub>c</sub> = 25°C unless otherwise noted.

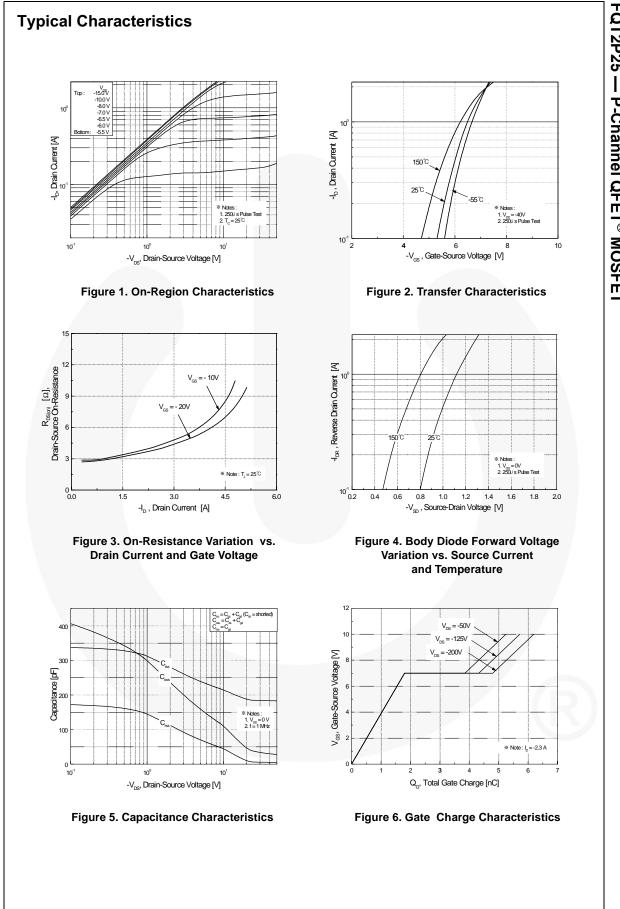
	<b>U</b>			
Symbol	Parameter	FQT2P25TF	Unit	
V <sub>DSS</sub>	Drain-Source Voltage		-250	V
I <sub>D</sub>	Drain Current - Continuous (T <sub>C</sub> = 25°	C)	-0.55	A
	- Continuous (T <sub>C</sub> = 100	)°C)	-0.35	А
I <sub>DM</sub>	Drain Current - Pulsed	(Note 1)	-2.2	A
V <sub>GSS</sub>	Gate-Source Voltage		± 30	V
E <sub>AS</sub>	Single Pulsed Avalanche Energy	(Note 2)	120	mJ
I <sub>AR</sub>	Avalanche Current	(Note 1)	-0.55	А
E <sub>AR</sub>	Repetitive Avalanche Energy	(Note 1)	0.25	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	-5.5	V/ns
P <sub>D</sub>	Power Dissipation ( $T_C = 25^{\circ}C$ )		2.5	W
	- Derate above 25°C		0.02	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Rar	-55 to +150	°C	
TL	Maximum lead temperature for soldering 1/8" from case for 5 seconds	300	°C	

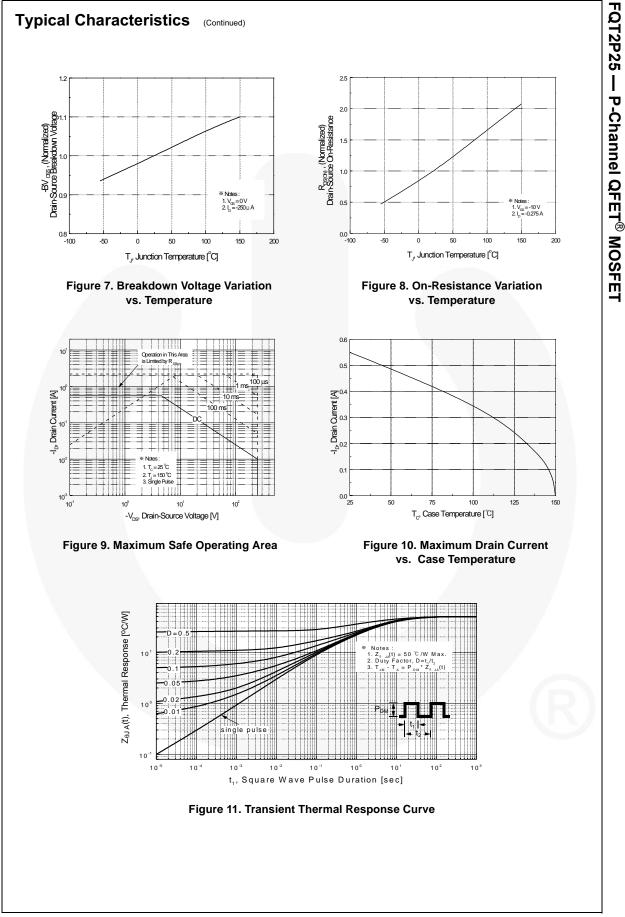
## **Thermal Characteristics**

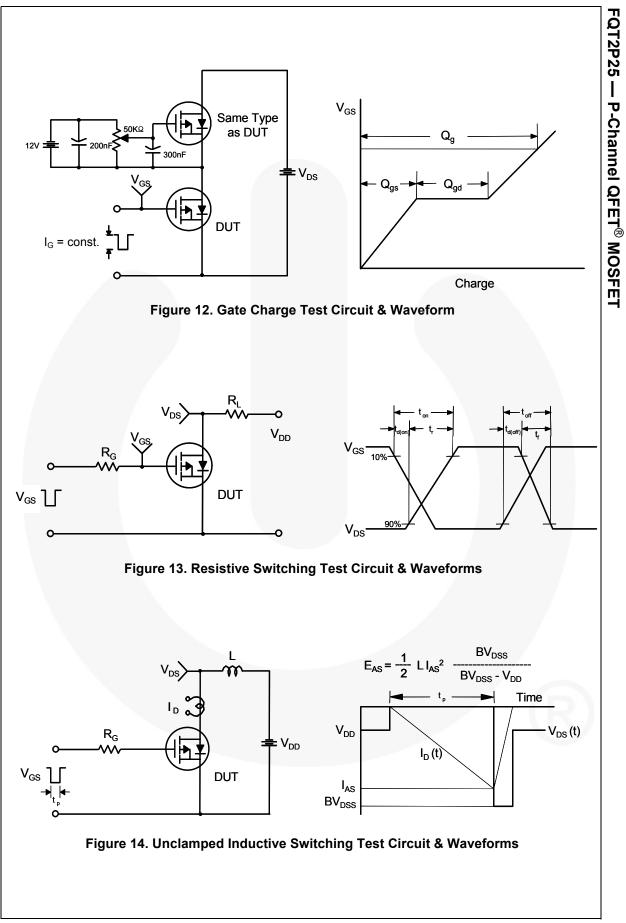
Symbol	Parameter	FQT2P25TF	Unit
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction-to-Ambient *	50	°C/W

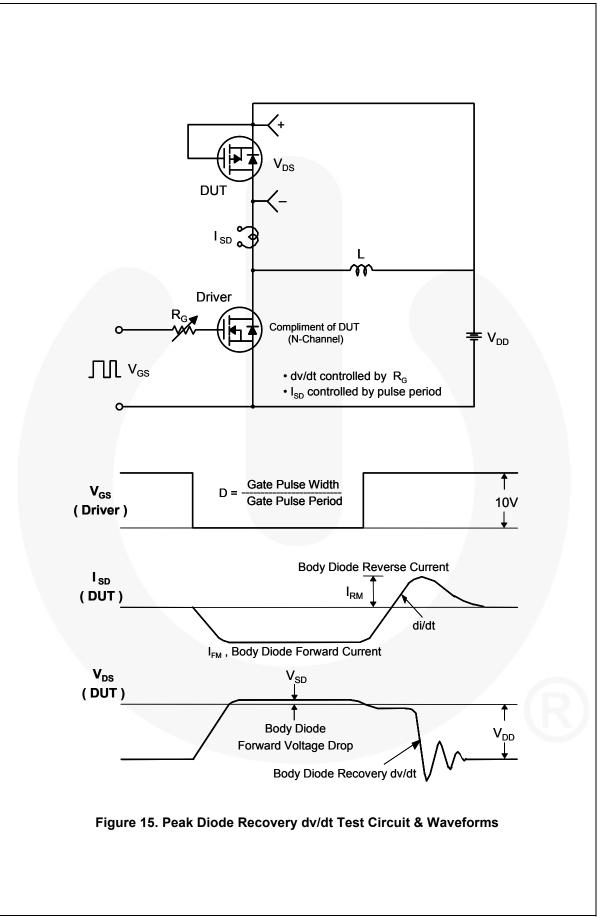
\* When mounted on the minimum pad size recommended (PCB Mount)

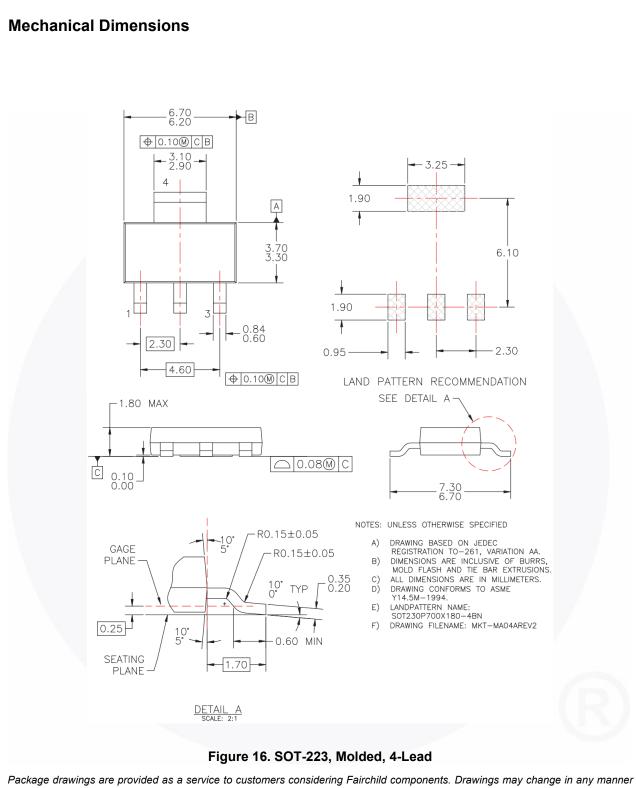
FQT2P2	mber	er Top Mark Pac		age	Packing Method	Reel	Size	Tape Wi	idth	Quantity
	FQT2P25TF FQT2P25		SOT	T-223 Tape and Reel 13		"	12 mm		4000 units	
lectri	cal Cl	naracteristics	T <sub>C</sub> = 25°C un	less otherv	vise noted.					
Symbol		Parameter			Test Conditions		Min	Тур	Max	Unit
Off Cha							1	1		
BV <sub>DSS</sub>	Drain-S	Source Breakdown Vol	tage	$V_{GS} = 0 V, I_D = -250 \mu A$			-250			V
ΔB <sub>VDSS</sub> /		Breakdown Voltage Temperature		$I_D = -250 \ \mu A$ , Referenced to 25°C			-0.2		V/°C	
$\Delta T_{J}$	Coeffic	ent	_							
I <sub>DSS</sub>	Zero G	ate Voltage Drain Curr	ent		$V_{DS} = -250 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$				-1	μΑ
				$V_{DS} = -200 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$				-10	μΑ	
		Body Leakage Current,		$V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$				-100	nA	
I <sub>GSSR</sub>	Gate-B	ody Leakage Current,	Reverse	V <sub>GS</sub> =	30 V, V <sub>DS</sub> = 0 V				100	nA
On Cha	ractori	istics								
V <sub>GS(th)</sub>		racteristics Gate Threshold Voltage		V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250 μA		-3.0		-5.0	V	
R <sub>DS(on)</sub>		0	_			-	-5.0		-5.0	v
TOS(on)		Static Drain-Source On-Resistance		V <sub>GS</sub> =	-10 V, I <sub>D</sub> = -0.275 A			3.15	4.0	Ω
9 <sub>FS</sub>	Forwar	d Transconductance	_	V <sub>DS</sub> =	-40 V, I <sub>D</sub> = -0.275 A			0.6		S
010			_	20						
Dynam	ic Cha	racteristics								
C <sub>iss</sub>	Input C	Capacitance		Vpc =	-25 V, V <sub>GS</sub> = 0 V,			190	250	pF
C <sub>oss</sub>	Output	Capacitance		f = 1.0  MHz			40	55	pF	
	Revers	e Transfer Capacitanc	е					6.5	8.5	pF
C <sub>rss</sub>	4		e					6.5	8.5	pF
C <sub>rss</sub>	ing Ch	aracteristics	e	1				6.5	8.5	pF
C <sub>rss</sub> Switchi	ing Ch		e	Vpp =	-125 V. In = -2.3 A.			6.5 8.5	8.5 25	pF ns
C <sub>rss</sub> Switchi	i <b>ng Ch</b> a Turn-O	aracteristics	e		-125 V, I <sub>D</sub> = -2.3 A, 25 Ω				I	
C <sub>rss</sub> Switchi t <sub>d(on)</sub> t <sub>r</sub>	i <b>ng Ch</b> a Turn-O Turn-O	aracteristics	e	V <sub>DD</sub> =	-			8.5	25	ns
C <sub>rss</sub> Switchi t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub>	i <b>ng Ch</b> a Turn-O Turn-O Turn-O	aracteristics In Delay Time In Rise Time	e		-	(Note 4)		8.5 40	25 90	ns
$\frac{c_{rss}}{switchi}$ $\frac{t_{d(on)}}{t_r}$ $\frac{t_{d(off)}}{t_f}$ $Q_g$	i <b>ng Ch</b> a Turn-O Turn-O Turn-O Turn-O	aracteristics In Delay Time In Rise Time Iff Delay Time	e	R <sub>G</sub> = 2	-	(Note 4)		8.5 40 12	25 90 35	ns ns ns
$\frac{C_{rss}}{Switchi}$ $\frac{f_{d(on)}}{t_r}$ $\frac{t_{d(off)}}{t_f}$ $\frac{Q_g}{Q_{gs}}$	ing Cha Turn-O Turn-O Turn-O Turn-O Total G	aracteristics In Delay Time In Rise Time Iff Delay Time Iff Fall Time	e	R <sub>G</sub> = 2	25 Ω -200 V, I <sub>D</sub> = -2.3 A,	(Note 4)	  	8.5 40 12 25	25 90 35 60	ns ns ns ns
$\frac{C_{rss}}{Switchi}$ $\frac{f_{d(on)}}{t_r}$ $\frac{t_{d(off)}}{t_f}$ $\frac{Q_g}{Q_{gs}}$	ing Cha Turn-O Turn-O Turn-O Turn-O Total G Gate-S	aracteristics on Delay Time on Rise Time off Delay Time off Fall Time cate Charge	e	R <sub>G</sub> = 2	25 Ω -200 V, I <sub>D</sub> = -2.3 A,	(Note 4) (Note 4)	    	8.5 40 12 25 6.5	25 90 35 60 8.5	ns ns ns ns nC
$\frac{C_{rss}}{Switchi}$ $\frac{Switchi}{t_{d(on)}}$ $\frac{t_r}{t_d(off)}$ $\frac{t_f}{Q_g}$ $Q_{gs}$ $Q_{gd}$	ing Cha Turn-O Turn-O Turn-O Turn-O Total G Gate-S Gate-E	aracteristics In Delay Time In Rise Time Iff Delay Time Iff Fall Time Iff Fall Time Iff Fall Charge Source Charge Drain Charge		$R_G = 2$ $V_{DS} =$ $V_{GS} =$	25 Ω -200 V, I <sub>D</sub> = -2.3 A, -10 V	(Note 4)	    	8.5 40 12 25 6.5 1.8	25 90 35 60 8.5 	ns ns ns ns nC nC
$\frac{C_{rss}}{Switchi}$ $\frac{Switchi}{t_{d(on)}}$ $\frac{t_r}{t_{d(off)}}$ $\frac{t_f}{Q_g}$ $Q_{gs}$ $Q_{gd}$	ing Cha Turn-O Turn-O Turn-O Turn-O Total G Gate-S Gate-E	aracteristics In Delay Time In Rise Time Iff Delay Time Iff Fall Time State Charge Source Charge		$R_G = 2$ $V_{DS} =$ $V_{GS} =$	25 Ω -200 V, I <sub>D</sub> = -2.3 A, -10 V	(Note 4)	    	8.5 40 12 25 6.5 1.8	25 90 35 60 8.5 	ns ns ns ns nC nC
$\frac{C_{rss}}{Switchi}$ $\frac{Switchi}{t_{d(on)}}$ $\frac{t_r}{t_{d(off)}}$ $\frac{t_f}{Q_g}$ $Q_{gs}$ $Q_{gd}$	ing Chi Turn-O Turn-O Turn-O Total G Gate-S Gate-D	aracteristics In Delay Time In Rise Time Iff Delay Time Iff Fall Time Iff Fall Time Iff Fall Charge Source Charge Drain Charge	istics a	$R_{G} = 2$ $V_{DS} =$ $V_{GS} =$ nd Max	25 Ω -200 V, I <sub>D</sub> = -2.3 A, -10 V <b>ximum Ratings</b>	(Note 4)	    	8.5 40 12 25 6.5 1.8	25 90 35 60 8.5 	ns ns ns ns nC nC
$\frac{C_{rss}}{Switchi}$ $\frac{Switchi}{t_{d(on)}}$ $\frac{t_{d(off)}}{t_{f}}$ $\frac{t_{d(off)}}{Q_{g}}$ $\frac{Q_{gs}}{Q_{gd}}$ Drain-S	ing Cha Turn-O Turn-O Turn-O Turn-O Total G Gate-S Gate-D Source Maxim	aracteristics In Delay Time In Rise Time Iff Delay Time Iff Fall Time Bate Charge Bource Charge Drain Charge	istics ai Source Dic	$R_{G} = 2$ $V_{DS} =$ $V_{GS} =$ $N_{GS} =$	25 Ω -200 V, I <sub>D</sub> = -2.3 A, -10 V ximum Ratings vard Current Current	(Note 4)	       	8.5 40 12 25 6.5 1.8 3.0	25 90 35 60 8.5  	ns ns ns nC nC nC
$\frac{C_{rss}}{Switchi}$ $\frac{Switchi}{t_{d(on)}}$ $\frac{t_{r}}{t_{f}}$ $\frac{Q_{g}}{Q_{gs}}$ $\frac{Q_{gg}}{Q_{gd}}$ $Drain-S$ $I_{S}$	ing Cha Turn-O Turn-O Turn-O Turn-O Total G Gate-S Gate-C Gource Maxim Maxim	aracteristics In Delay Time In Rise Time Iff Delay Time Iff Fall Time Iff Fall Time Iff Charge Dource Charge Drain Charge Diode Character Imme Continuous Drain-5	<b>istics a</b> Source Dic ce Diode F	$R_{G} = 2$ $V_{DS} =$ $V_{GS} =$ $N_{GS} =$	25 Ω -200 V, $I_D = -2.3$ A, -10 V <b>ximum Ratings</b> vard Current Current 0 V, $I_S = -0.55$ A	(Note 4)	      	8.5 40 12 25 6.5 1.8 3.0	25 90 35 60 8.5   	ns ns ns nC nC nC A
Crss           Switchi           td(on)           tr           td(off)           tf           Qg           Qgs           Qgd           Drain-S           Is	ing Cha Turn-O Turn-O Turn-O Turn-O Total G Gate-S Gate-D Source Maxim Maxim Drain-S	aracteristics In Delay Time In Rise Time Iff Delay Time Iff Fall Time Source Charge Drain Charge Diode Character um Continuous Drain-Source	<b>istics a</b> Source Dic ce Diode F	$R_{G} = 2$ $V_{DS} =$ $V_{GS} =$ $V_{GS} =$ $V_{GS} =$ $V_{GS} =$ $V_{GS} =$ $V_{GS} =$	25 Ω -200 V, I <sub>D</sub> = -2.3 A, -10 V ximum Ratings vard Current Current	(Note 4)	      	8.5 40 12 25 6.5 1.8 3.0	25 90 35 60 8.5    -0.55 -2.2	ns ns ns nC nC nC A A











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